May 2009

FDMS8670S N-Channel PowerTrench[®] SyncFETTM 30V, 42A, 3.5mΩ

Features

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- Max $r_{DS(on)}$ = 3.5m Ω at V_{GS} = 10V, I_D = 20A
- Max r_{DS(on)} = 5.0mΩ at V_{GS} = 4.5V, I_D = 17A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- RoHS Compliant

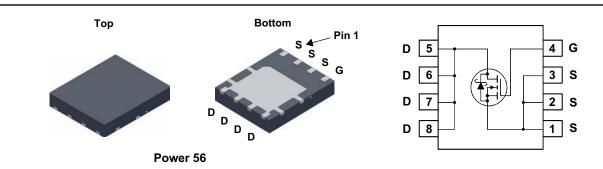


General Description

The FDMS8670S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

Application

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/ GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



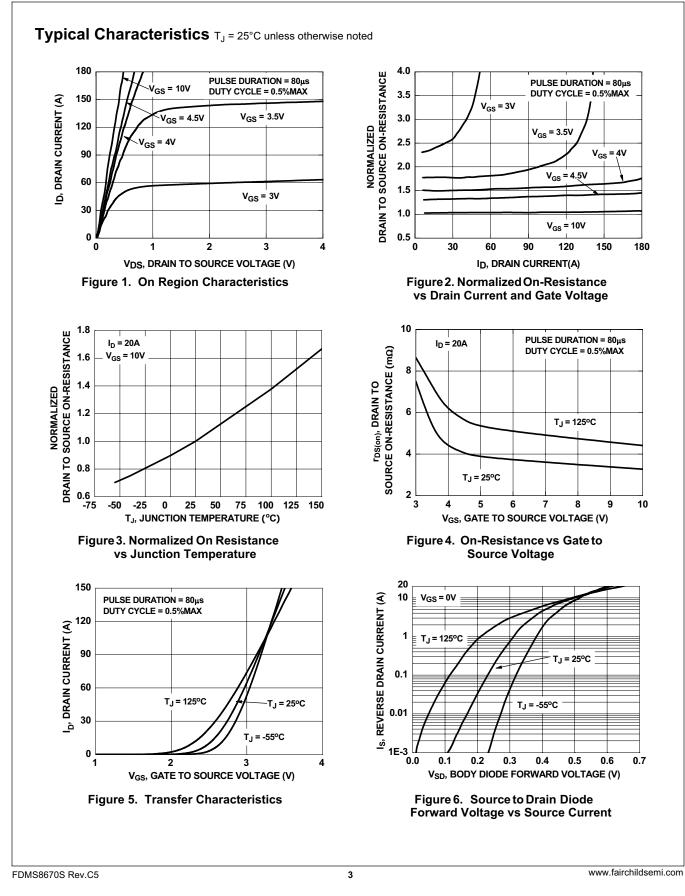
MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

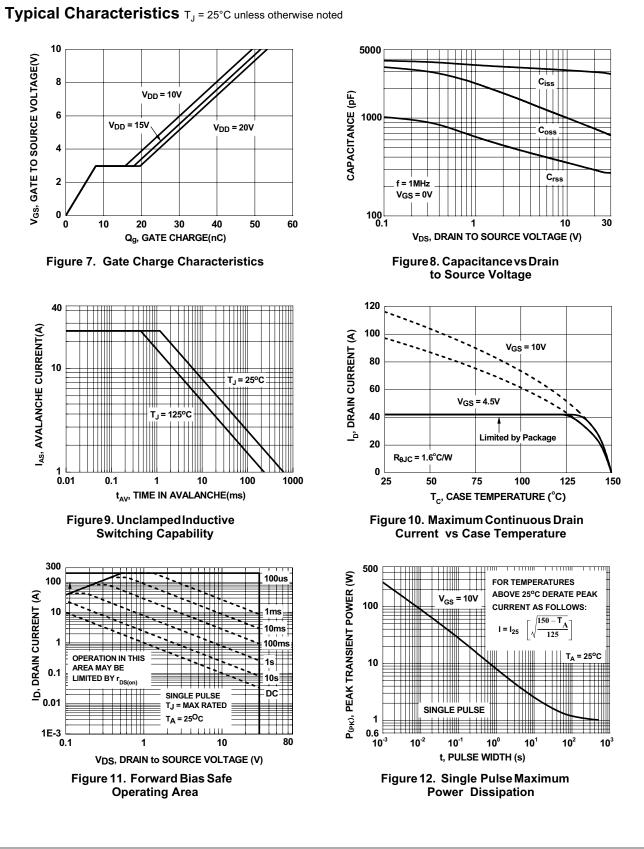
Symbol	Parameter				Ratings		Units			
V _{DS}	Drain to	Drain to Source Voltage				30		V		
V _{GS}	Gate to	Gate to Source Voltage				±20		V		
ID	Drain C	ain Current -Continuous (Package limited) T _C = 25°C								
		-Continuous (Silicon limited) $T_c = 25^{\circ}C$								
		-Continuous (Silicon limited) T _C = 100°C 74						A		
		-Continuous	T _A =	25°C		20				
		-Pulsed				200				
P _D	Power D	Dissipation	T _C =	25°C		78				
	Power Dissipation T _A =			25°C	(Note 1a)	2.5		W		
	Power D	Power Dissipation $T_A = 85^{\circ}C$			(Note 1a)	1.3		1		
T _J , T _{STG}	Operatii	Operating and Storage Junction Temperature Range			-55 to +150		°C			
Thermal Cl								1		
R _{0JC}	Thermal Resistance, Junction to Case			1.6		°C/W				
R _{0JA}	Therma	Thermal Resistance, Junction to Ambient(Note 1a)					50			
Package M	arking a	nd Ordering Informat	tion							
Device Marking		Device	Package		Reel Size	Tape Width Qu		antity		
FDMS86	670S	FDMS8670S	Power 56		13"	12mm	3000 units			

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1mA, V _{GS} = 0V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 10mA, referenced to 25°C		17		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24V, V _{GS} = 0V			500	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	ctoristics					
	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 1mA$	1	1.5	3	V
V _{GS(th)}	Gate to Source Threshold Voltage	$v_{GS} - v_{DS}$, $r_D - rrrA$	I	1.5	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Temperature Coefficient	$I_D = 50$ mA, referenced to 25°C		-2.8		mV/°C
		V _{GS} = 10V, I _D = 20A		2.8	3.5	-
r _{DS(on)}	Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 17A$	3.6	5.0	mΩ	
		$V_{GS} = 10V, I_D = 20A, T_J = 125^{\circ}C$		3.9	6.0	<u> </u>
9 _{FS}	Forward Transconductance	V _{DS} = 10V, I _D = 20A		98		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$y_{1} = 45y_{1}y_{2} = 0y_{1}$		3005	4000	pF
C _{oss}	Output Capacitance	──V _{DS} = 15V, V _{GS} = 0V ──f = 1MHz		865	1150	pF
C _{rss}	Reverse Transfer Capacitance			320	480	pF
R _g	Gate Resistance	f = 1MHz		1.4	5.0	Ω
Switching	Characteristics					
-	Turn-On Delay Time			14	26	ns
t _{d(on)} t _r	Rise Time	V _{DD} = 15V, I _D = 20A		19	35	ns
-	Turn-Off Delay Time	—V _{GS} = 10V, R _{GEN} = 5Ω		37	60	ns
t _{d(off)} t _f	Fall Time			10	20	ns
Q _{g(TOT)}	Total Gate Charge at 10V	V _{GS} = 0V to 10V		52	73	nC
Q _{g(4.5V)}	Total Gate Charge at 4.5V	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DS} = 15V$		24	34	nC
Q _{gs}	Gate to Source Gate Charge	$I_{\rm D} = 20A$		8		nC
Q _{gd}	Gate to Drain "Miller" Charge			10		nC
-	urce Diode Characteristics				1	
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = 2A		0.4	0.7	V
t _{rr}	Reverse Recovery Time			26	42	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 20A, di/dt = 300A/μs		20	39	nC
Notes: 1: R _{0JA} is determ the user's boz	a. 50°C/W when mount a 1 in ² pad 2 oz copper pa a. 50°C/W when mount a 1 in ² pad of 2 oz copp	ted on b. '	25°C/W wh	by design wl	on a	etermined b
2: Pulse time < 3	300μs, Duty cycle < 2%.					
						airchildser

Electrical Characteristics T_J = 25°C unless otherwise noted



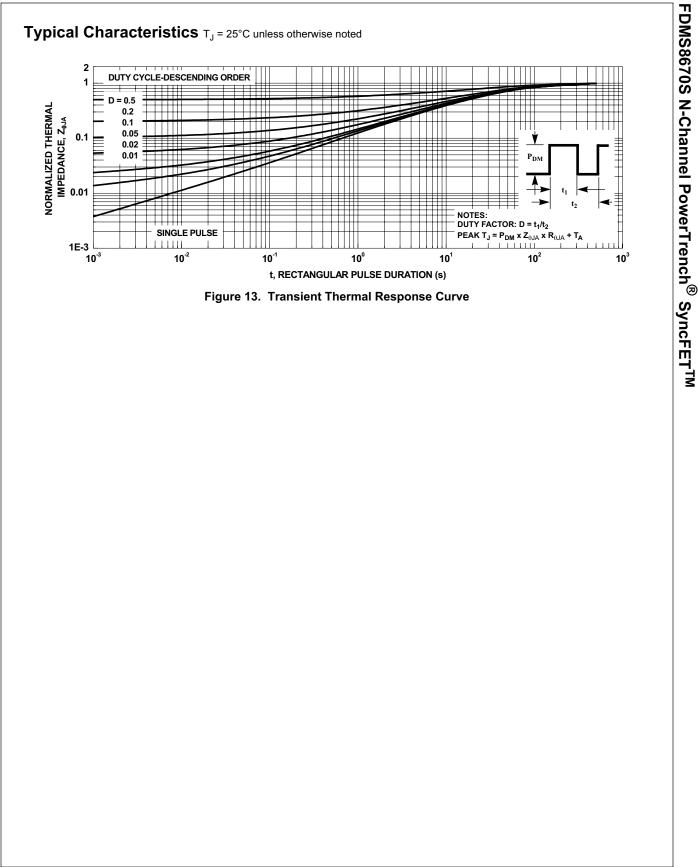


FDMS8670S Rev.C5

4

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Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS8670S.

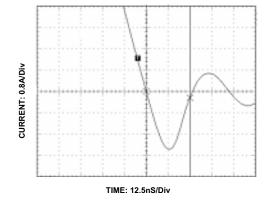
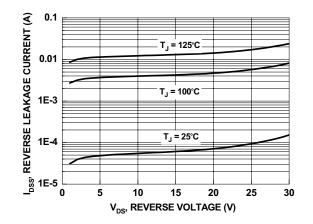
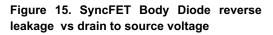


Figure 14. FDMS8670S SyncFET Body Diode reverse recovery characteristics

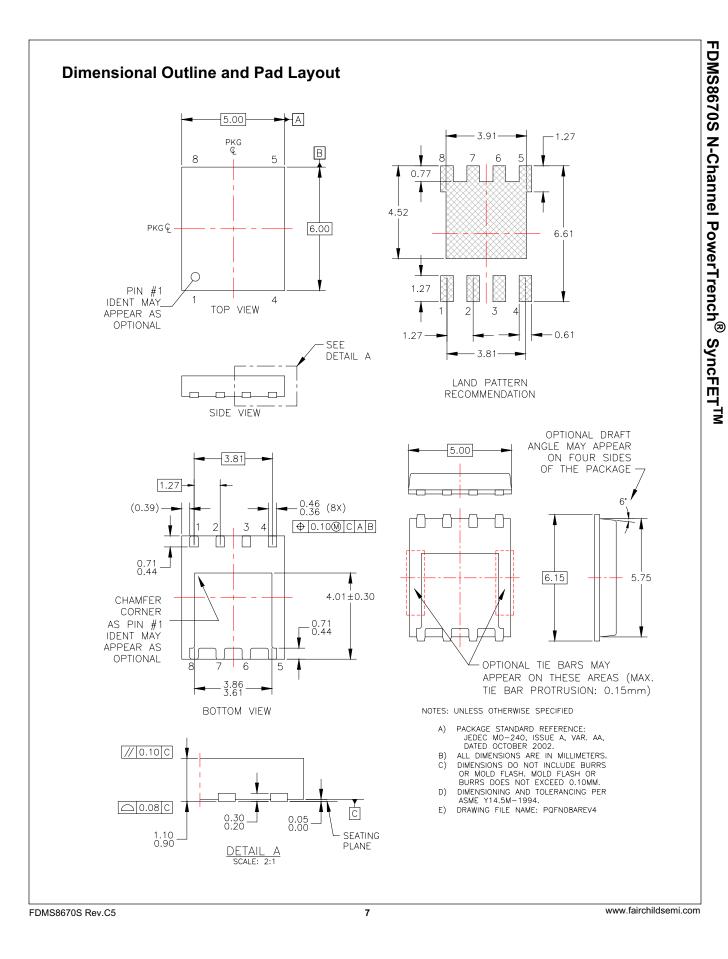
Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.





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